EVALUATION KIT AVAILABLE

MAXIM

DirectDrive Headphone Amplifier with External Gain

MAX9820

General Description

The MAX9820 Windows Vista®-compliant stereo headphone amplifier is designed for portable equipment where board space is at a premium. It features Maxim's DirectDrive® architecture to produce a ground-referenced output from a single supply, eliminating the large output-coupling capacitors required by conventional single-supply headphone amplifiers.

The MAX9820 features an undervoltage lockout that prevents over discharging of the battery during brownout conditions, click-and-pop suppression that eliminates audible transients on startup, a low-power shutdown mode, and thermal-overload and short-circuit protection. Additionally, the MAX9820 suppresses RF radiation received by input and supply traces acting as antennas and prevents the amplifier from demodulating the coupled noise.

The MAX9820 is available in a 10-pin TDFN package (3mm x 3mm x 0.8mm) and specified over the -40°C to +85°C extended temperature range.

Applications

Cell Phones

MP3 Players

Notebook PCs

PDAs
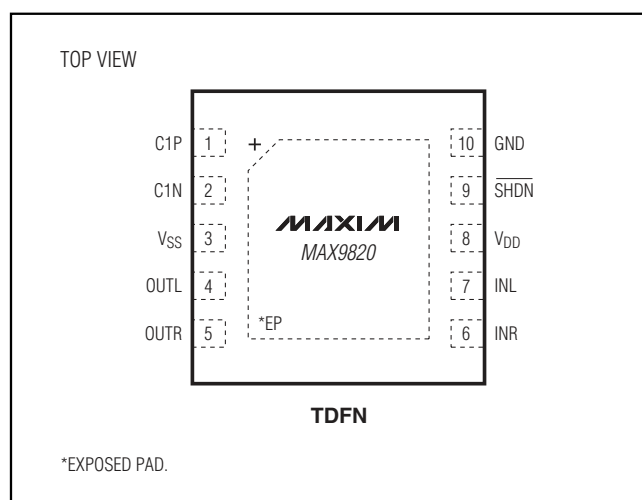
Features

♦ **Clickless/Popless Operation**

♦ **High RF Noise Rejection**

♦ **Windows Vista Premium Mobile Compliant**

♦ **2.7V to 5.5V Single-Supply Operation**

♦ **95mW Output Power (32Ω, V_{DD} = 5V)**

♦ **Low-Current Shutdown Mode, < 1µA**

♦ **Low 3mA (V_{DD} = 3.3V) Quiescent Current**

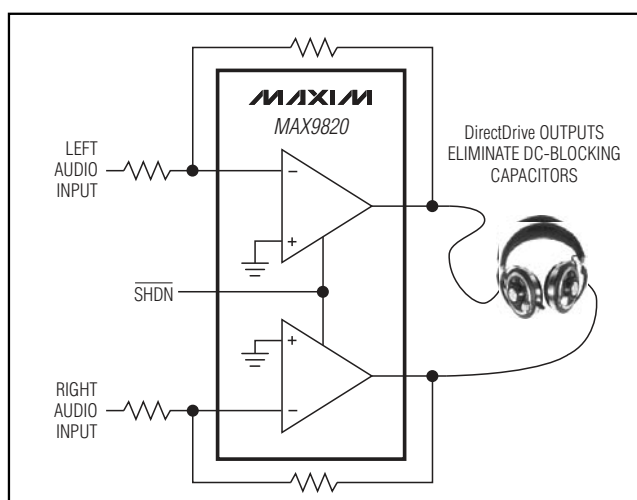♦ **Space-Saving, 3mm x 3mm, 10-Pin TDFN Package**

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE	TOP MARK
MAX9820ETB+	-40°C to +85°C	10 TDFN-EP*	AUU

+Denotes a lead(Pb)-free/RoHS-compliant package.

*EP = Exposed pad.

Pin Configuration

TOP VIEW

C1P 1 · C1N 2 · V$_{SS}$ 3 · OUTL 4 · OUTR 5 · MAX9820 · *EP · 10 GND · 9 $\overline{SHDN}$ · 8 V$_{DD}$ · 7 INL · 6 INR

TDFN

*EXPOSED PAD.

Simplified Block Diagram

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MAX9820

LEFT AUDIO INPUT

RIGHT AUDIO INPUT

$\overline{SHDN}$

DirectDrive OUTPUTS ELIMINATE DC-BLOCKING CAPACITORS

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DirectDrive is a registered trademark of Maxim Integrated Products, Inc.

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For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

DirectDrive Headphone Amplifier with External Gain

ABSOLUTE MAXIMUM RATINGS

V_{DD} to GND ....-0.3V to +6V
C1P to GND...-0.3V to (V_{DD} + 0.3V)
C1N to GND...(V_{SS} - 0.3V) to +0.3V
V_{SS} to GND...-6V to +0.3V
$\overline{OUTR}$, OUTL to GND...±3V
$\overline{SHDN}$ to GND...-0.3V to +6V
INR, INL to GND ....-0.3V to (V_{DD} + 0.3V)
OUTR, OUTL Short Circuit to GND, V_{DD}...................Continuous
Short Circuit Between OUTL and OUTR ....Continuous
Continuous Input Current (Into All Other Pins) ....±20mA
Continuous Power Dissipation (T_A = +70°C)
   10-Pin TDFN Single-Layer PCB (derate 18.5mW/°C
     above +70°C)...1481.5mW
Junction-to-Case Thermal Resistance (θ_{JC}) (Note 1)
   10-Pin TDFN ....8.5°C/W

Junction-to-Ambient Thermal Resistance (θ_{JA}) (Note 1)
   10-Pin TDFN...41.0°C/W
Continuous Power Dissipation (T_A = +70°C)
   10-Pin TDFN Multilayer PCB (derate 24.4mW/°C
     above +70°C)..1951mW
Junction-to-Case Thermal Resistance (θ_{JC}) (Note 1)
   10-Pin TDFN ....9.0°C/W
Junction-to-Ambient Thermal Resistance (θ_{JA}) (Note 1)
   10-Pin TDFN...41.0°C/W
Operating Temperature Range ....-40°C to +85°C
Storage Temperature Range ....-65°C to +150°C
Junction Temperature...+150°C
Lead Temperature (soldering, 10s) ....+300°C

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to **www.maxim-ic.com/thermal-tutorial**.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{DD} = $V_{\overline{SHDN}}$ = 5V, V_{GND} = 0V, R_{IN} = R_{FB} = 40.2kΩ (gain = -1V/V), C1 = C2 = 1µF, C3 = 10µF, R_{LOAD} = ∞, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C, unless otherwise noted.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
GENERAL							
Supply Voltage Range	V_{DD}	Guaranteed by PSRR test		2.7		5.5	V
Undervoltage Lockout	UVLO				2.2		V
Quiescent Current	I_{DD}	V_{DD} = 3.3V			3.0	4.6	mA
		V_{DD} = 5V			4.0	6.0	
Shutdown Current	$I_{\overline{SHDN}}$	$V_{\overline{SHDN}}$ = 0V, T_A = +25°C			< 0.1	1	µA
Output Signal Attenuation in Shutdown		$V_{\overline{SHDN}}$ = 0V, V_{IN} = 1V_{RMS}, R_{LOAD} = 10kΩ			-110		dBV
Output Impedance in Shutdown		$V_{\overline{SHDN}}$ = 0V			0.6		kΩ
Turn-On Time	t_{ON}				0.56		ms
Output Offset Voltage	V_{OS}	T_A = +25°C (Note 3)			±0.1	±0.5	mV
Click-and-Pop Level	K_{CP}	Z_{LOAD} = 32Ω + 1µH, peak voltage, A-weighted, 32 samples per second (Notes 3, 4)	Into shutdown		-79		dBV
			Out of shutdown		-77		
		Z_{LOAD} = 10kΩ, peak voltage, A-weighted, 32 samples per second (Notes 3, 4)	Into shutdown		-62		
			Out of shutdown		-58		

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ELECTRICAL CHARACTERISTICS (continued)

(V_{DD} = $V_{\overline{SHDN}}$ = 5V, V_{GND} = 0V, R_{IN} = R_{FB} = 40.2kΩ (gain = -1V/V), C1 = C2 = 1μF, C3 = 10μF, R_{LOAD} = ∞, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C, unless otherwise noted.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Power-Supply Rejection Ratio	PSRR	V_{DD} = 2.7V to 5.5V, T_A = +25°C (Note 3)		75	90		dB
		f = 1kHz, 200mV$_{P-P}$ (Note 3)			73		
		f = 20kHz, 200mV$_{P-P}$ (Note 3)			55		
Output Power	P_{OUT}	Z_{LOAD}= 32Ω + 1μH, f = 1kHz, THD+N = 1%	V_{DD} = 3.6V		45		mW
			V_{DD} = 5.0V		95		
		Z_{LOAD}= 16Ω + 1μH, f = 1kHz, THD+N = 1%	V_{DD} = 3.6V		32		
			V_{DD} = 5.0V		75		
Total Harmonic Distortion Plus Noise	THD+N	Z_{LOAD} = 16Ω + 1μH, f = 1kHz, P_{OUT} = 20mW			0.014		%
		Z_{LOAD} = 32Ω + 1μH, f = 1kHz, P_{OUT} = 20mW			0.005		
		Z_{LOAD} = 10kΩ, f = 1kHz, V_{OUT} = 1V$_{RMS}$			0.001		
Signal-to-Noise Ratio	SNR	Z_{LOAD} = 32Ω + 1μH, P_{OUT} = 25mW, A-weighted			105		dB
Output Noise	V_{NOISE}	A-weighted (Note 3)			9		μV
Crosstalk		L to R, R to L, BW = 20Hz to 15kHz	Z_{LOAD} = 32Ω + 1μH FS = 0.300V$_{RMS}$, V_{OUT} = 30mV$_{RMS}$		73		dB
			Z_{LOAD} = 10kΩ FS = 0.707V$_{RMS}$, V_{OUT} = 70.7mV$_{RMS}$		73		
Capacitive Load Drive	C_L	No sustained oscillations			200		pF
Oscillator Frequency	f_{OSC}	T_A = +25°C		300	500	800	kHz
Thermal Shutdown					145		°C
Thermal Shutdown Hysteresis					15		°C
DIGITAL INPUT ($\overline{SHDN}$)							
Input Voltage High	V_{INH}			1.2			V
Input Voltage Low	V_{INL}					0.3	V
Input Leakage Current	$I_{LEAKAGE}$	T_A = +25°C				±1	μA

Note 2: All specifications are 100% tested at T_A = +25°C; temperature limits are guaranteed by design.
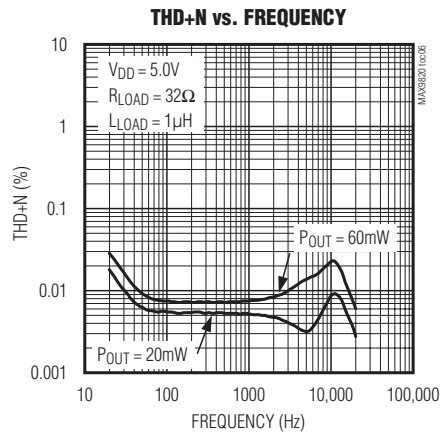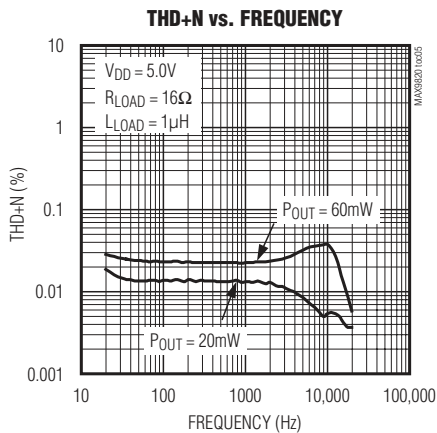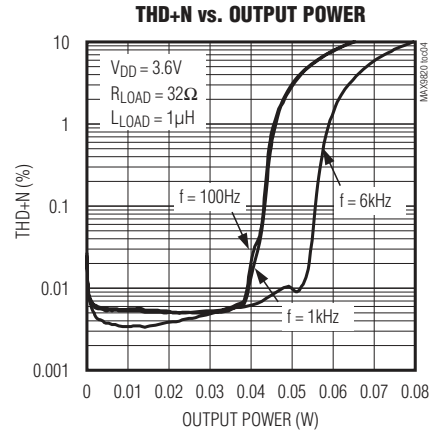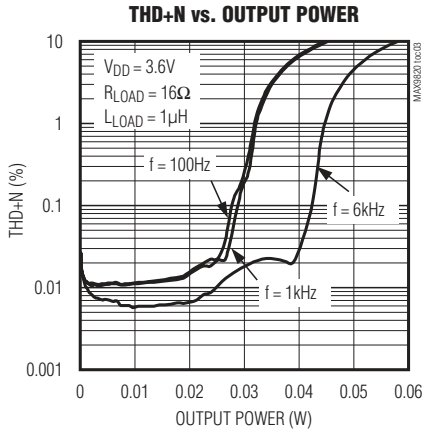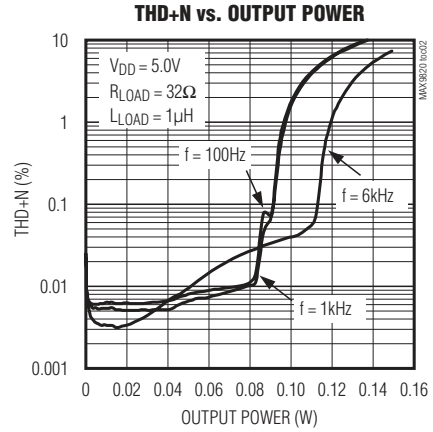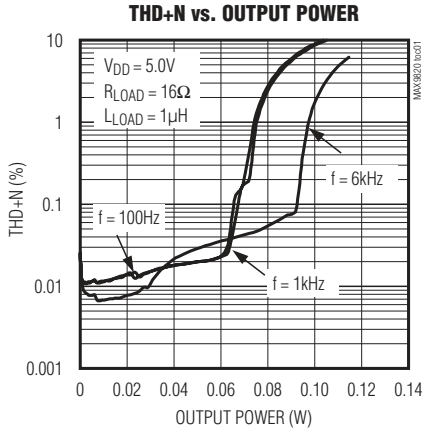**Note 3:** The amplifier inputs are AC-coupled to GND.
Note 4: Mode transitions are controlled by $\overline{SHDN}$.

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DirectDrive Headphone Amplifier with External Gain

Typical Operating Characteristics

(V_{DD} = $V_{\overline{SHDN}}$ = 5V, V_{GND} = 0V, R_{IN} = R_{FB} = 40.2kΩ (gain = -1V/V), C1 = C2 = 1µF, C3 = 10µF, R_{LOAD} = ∞. Typical values are at T_A = +25°C, unless otherwise noted.)
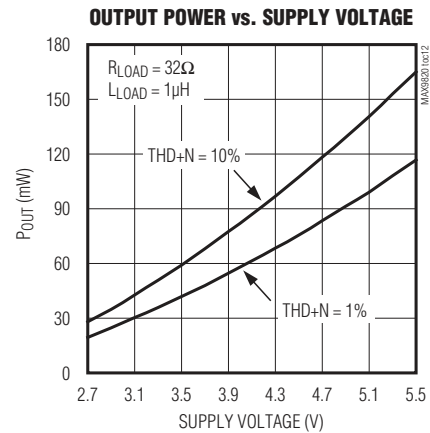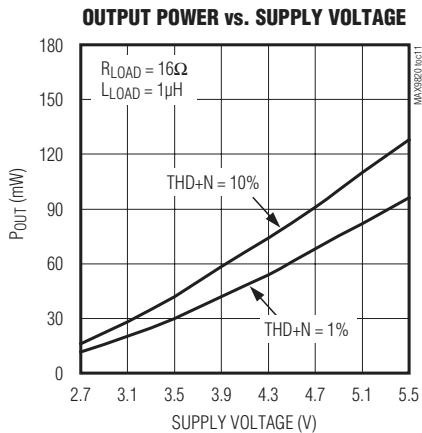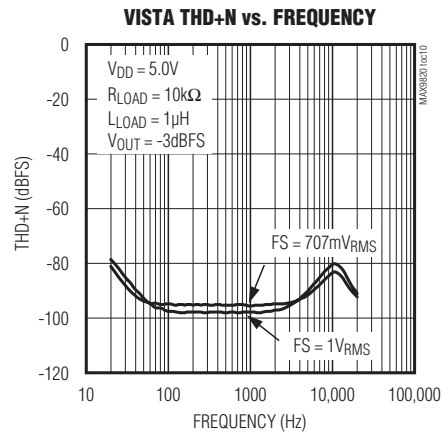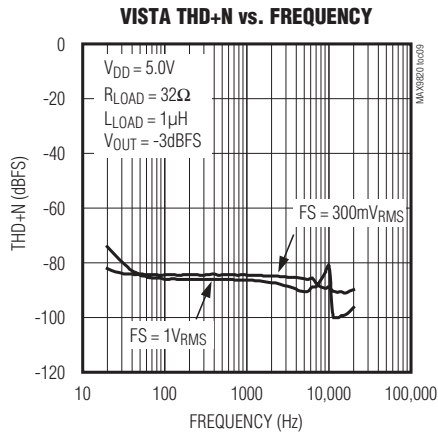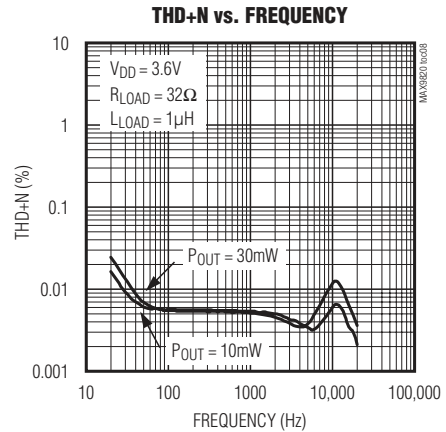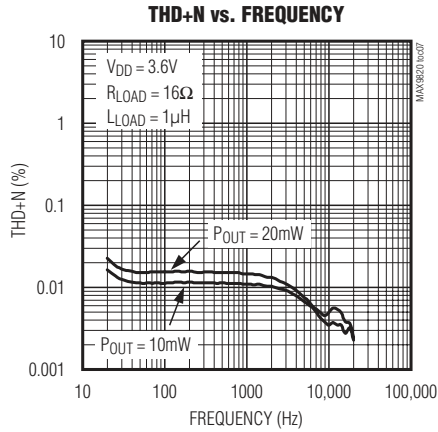

THD+N vs. OUTPUT POWER

V_{DD} = 5.0V
R_{LOAD} = 16Ω
L_{LOAD} = 1µH

f = 6kHz
f = 100Hz
f = 1kHz

THD+N vs. OUTPUT POWER

V_{DD} = 5.0V
R_{LOAD} = 32Ω
L_{LOAD} = 1µH

f = 100Hz
f = 6kHz
f = 1kHz

THD+N vs. OUTPUT POWER

V_{DD} = 3.6V
R_{LOAD} = 16Ω
L_{LOAD} = 1µH

f = 100Hz
f = 6kHz
f = 1kHz

THD+N vs. OUTPUT POWER

V_{DD} = 3.6V
R_{LOAD} = 32Ω
L_{LOAD} = 1µH

f = 100Hz
f = 6kHz
f = 1kHz

THD+N vs. FREQUENCY

V_{DD} = 5.0V
R_{LOAD} = 16Ω
L_{LOAD} = 1µH

P_{OUT} = 60mW
P_{OUT} = 20mW

THD+N vs. FREQUENCY

V_{DD} = 5.0V
R_{LOAD} = 32Ω
L_{LOAD} = 1µH

P_{OUT} = 60mW
P_{OUT} = 20mW

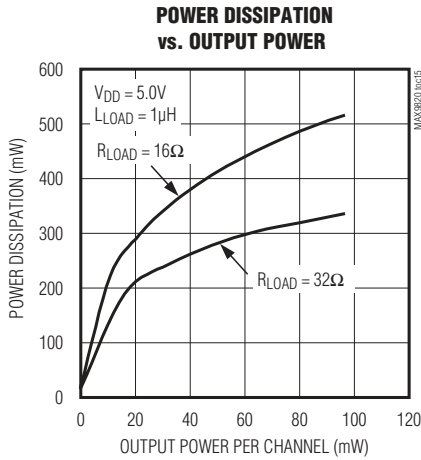**МАХ1М**

MAX9820

Typical Operating Characteristics

(V_{DD} = $V_{\overline{SHDN}}$ = 5V, V_{GND} = 0V, R_{IN} = R_{FB} = 40.2kΩ (gain = -1V/V), C1 = C2 = 1µF, C3 = 10µF, R_{LOAD} = ∞. Typical values are at T_A = +25°C, unless otherwise noted.)

THD+N vs. FREQUENCY

V_{DD} = 3.6V
R_{LOAD} = 16Ω
L_{LOAD} = 1µH

P_{OUT} = 20mW

P_{OUT} = 10mW

THD+N vs. FREQUENCY

V_{DD} = 3.6V
R_{LOAD} = 32Ω
L_{LOAD} = 1µH

P_{OUT} = 30mW

P_{OUT} = 10mW

VISTA THD+N vs. FREQUENCY

V_{DD} = 5.0V
R_{LOAD} = 32Ω
L_{LOAD} = 1µH
V_{OUT} = -3dBFS

FS = 300mV_{RMS}

FS = 1V_{RMS}

VISTA THD+N vs. FREQUENCY

V_{DD} = 5.0V
R_{LOAD} = 10kΩ
L_{LOAD} = 1µH
V_{OUT} = -3dBFS

FS = 707mV_{RMS}

FS = 1V_{RMS}

OUTPUT POWER vs. SUPPLY VOLTAGE

R_{LOAD} = 16Ω
L_{LOAD} = 1µH

THD+N = 10%

THD+N = 1%

OUTPUT POWER vs. SUPPLY VOLTAGE

R_{LOAD} = 32Ω
L_{LOAD} = 1µH

THD+N = 10%

THD+N = 1%

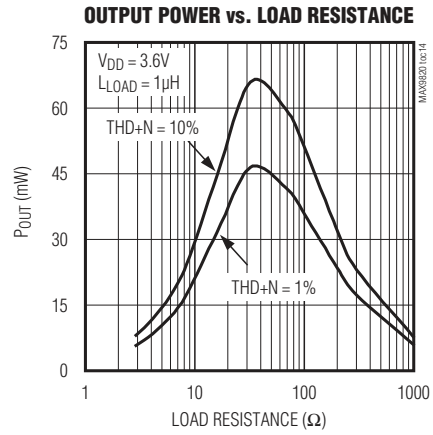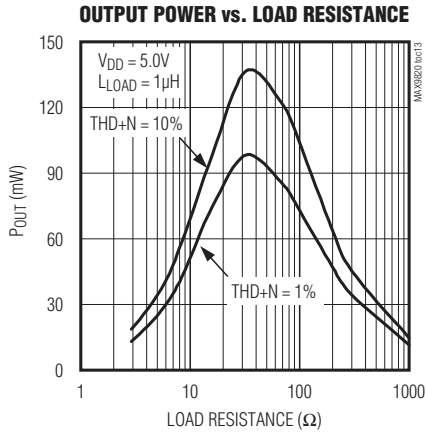**MAX9820**

Typical Operating Characteristics (continued)

$(V_{DD} = V_{\overline{SHDN}} = 5V, V_{GND} = 0V, R_{IN} = R_{FB} = 40.2k\Omega$ (gain = -1V/V), C1 = C2 = 1µF, C3 = 10µF, $R_{LOAD} = \infty$. Typical values are at $T_A = +25°C$, unless otherwise noted.)

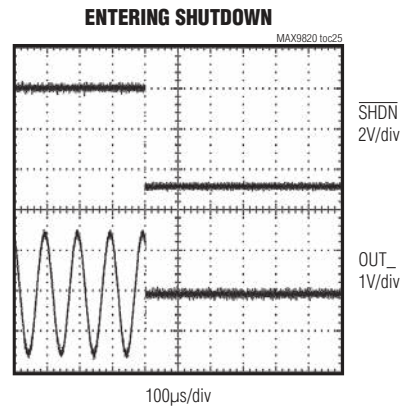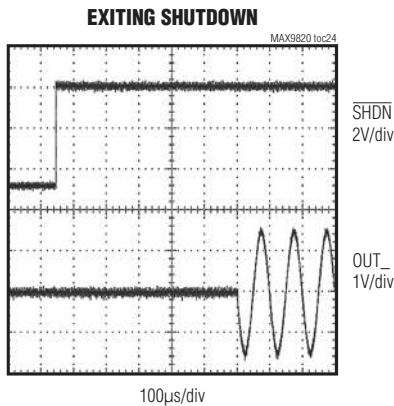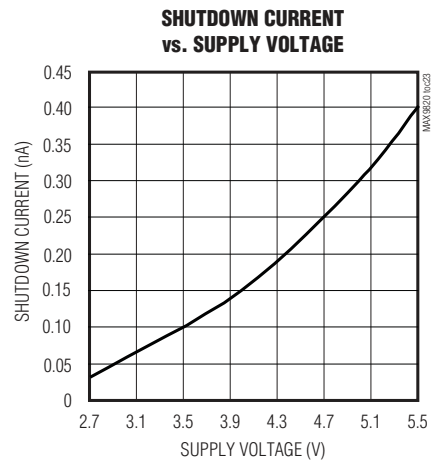**OUTPUT POWER vs. LOAD RESISTANCE**

OUTPUT POWER vs. LOAD RESISTANCE

POWER DISSIPATION vs. OUTPUT POWER

POWER DISSIPATION vs. OUTPUT POWER

POWER-SUPPLY REJECTION RATIO vs. FREQUENCY

POWER-SUPPLY REJECTION RATIO vs. SUPPLY VOLTAGE

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(V_{DD} = $V_{\overline{SHDN}}$ = 5V, V_{GND} = 0V, R_{IN} = R_{FB} = 40.2kΩ (gain = -1V/V), C1 = C2 = 1µF, C3 = 10µF, R_{LOAD} = ∞. Typical values are at T_A = +25°C, unless otherwise noted.)

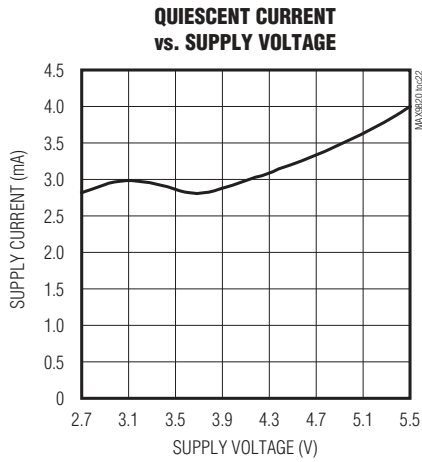### VISTA CROSSTALK vs. FREQUENCY

R_{LOAD} = 32Ω
L_{LOAD} = 1µH
FS = 300mV$_{RMS}$
V_{OUT} = -20dBFS

LEFT TO RIGHT

RIGHT TO LEFT

CROSSTALK (dB) vs FREQUENCY (Hz)

VISTA CROSSTALK vs. FREQUENCY

R_{LOAD} = 1kΩ
L_{LOAD} = 1µH
FS = 707mV$_{RMS}$
V_{OUT} = -20dBFS

LEFT TO RIGHT

RIGHT TO LEFT

CROSSTALK (dB) vs FREQUENCY (Hz)

OUTPUT SPECTRUM

f = 1kHz
R_{LOAD} = 32Ω
L_{LOAD} = 1µH

OUTPUT MAGNITUDE (dBV) vs FREQUENCY (kHz)

QUIESCENT CURRENT vs. SUPPLY VOLTAGE

SUPPLY CURRENT (mA) vs SUPPLY VOLTAGE (V)

SHUTDOWN CURRENT vs. SUPPLY VOLTAGE

SHUTDOWN CURRENT (nA) vs SUPPLY VOLTAGE (V)

EXITING SHUTDOWN

$\overline{SHDN}$
2V/div

OUT_
1V/div

100µs/div

ENTERING SHUTDOWN

$\overline{SHDN}$
2V/div

OUT_
1V/div

100µs/div

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PIN	NAME	FUNCTION
1	C1P	Flying Capacitor Positive Terminal. Connect a 1μF ceramic capacitor from C1P to C1N.
2	C1N	Flying Capacitor Negative Terminal. Connect a 1μF ceramic capacitor from C1N to C1P.
3	V_{SS}	Charge-Pump Output. Bypass with a 1μF capacitor to GND.
4	OUTL	Left-Channel Output
5	OUTR	Right-Channel Output
6	INR	Right-Channel Input
7	INL	Left-Channel Input
8	V_{DD}	Positive Power-Supply Input. Bypass with a 10μF capacitor to GND.
9	$\overline{SHDN}$	Active-Low Shutdown Input
10	GND	Signal Ground
—	EP	Exposed Pad. Internally connected to GND. Connect to a large ground plane to maximize thermal performance. Not intended as an electrical connection point.

_____Detailed Description

The MAX9820 95mW stereo headphone amplifier features Maxim's DirectDrive architecture, eliminating the large output-coupling capacitors required by conventional single-supply headphone amplifiers. The device features low RF susceptibility, extensive click-and-pop suppression, undervoltage lockout (UVLO) and shutdown control. The MAX9820 also features thermal-overload and short-circuit protection.

The MAX9820 is Windows Vista Premium Mobile compliant (Table 1).

DirectDrive

Conventional single-supply headphone amplifiers have their outputs biased about a nominal DC voltage (typically half the supply) for maximum dynamic range. Large-coupling capacitors are needed to block this DC bias from the headphone. Without these capacitors, a significant amount of DC current flows to the headphone, resulting in unnecessary power dissipation and possible damage to both headphone and headphone amplifier.

Maxim's DirectDrive architecture uses a charge pump to create an internal negative supply voltage, allowing the MAX9820 outputs to be biased at

Table 1. Windows Vista Premium Mobile Specifications vs. MAX9820 Specifications

DEVICE TYPE	REQUIREMENT	WINDOWS VISTA PREMIUM MOBILE SPECIFICATIONS	MAX9820 TYPICAL PERFORMANCE
Analog Line Output Jack (R_L = 10kΩ, FS = 0.707V_{RMS})	THD+N	≤ -65dB FS (100Hz, 20kHz)	-83dBFS (100Hz, 20kHz)
	Dynamic range with signal present	≤ -80dBV, A-weighted (20Hz, 20kHz)	-101dB A-weighted (20Hz, 20kHz)
	Line output crosstalk	≤ -50dB (20Hz, 15kHz)	-73dB (20Hz, 15kHz)
Analog Headphone Out Jack (R_L = 32Ω, FS = 0.300V_{RMS})	THD+N	≤ -45dB FS (100Hz, 20kHz)	-85dBFS (100Hz, 20kHz)
	Dynamic range with signal present	≤ -60dBV, A-weighted (20Hz, 20kHz)	-94dB A-weighted (20Hz, 20kHz)
	Headphone output crosstalk	≤ -50dB (20Hz, 15kHz)	-73dB (20Hz, 15kHz)

Note: *THD+N, dynamic range, and crosstalk are measured in accordance with AES-17 audio measurements standards.*

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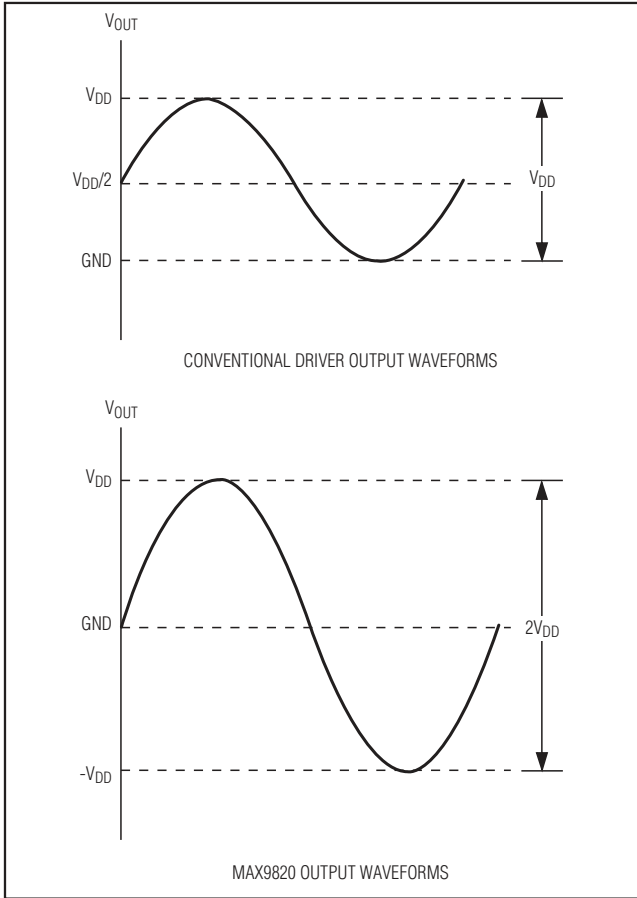
Figure 1. Conventional Driver Output Waveform vs. MAX9820 Output Waveform

Figure 2. MAX9820 RF Susceptibility

GND (Figure 1). With no DC component, there is no need for the large DC-blocking capacitors. The MAX9820 charge pump requires two small ceramic capacitors, conserving board space, reducing cost, and improving the frequency response of the headphone amplifier.

Charge Pump

The MAX9820 features a low-noise charge pump. The 500kHz (typ) charge pump switching frequency is well beyond the audio range and does not interfere with audio signals.
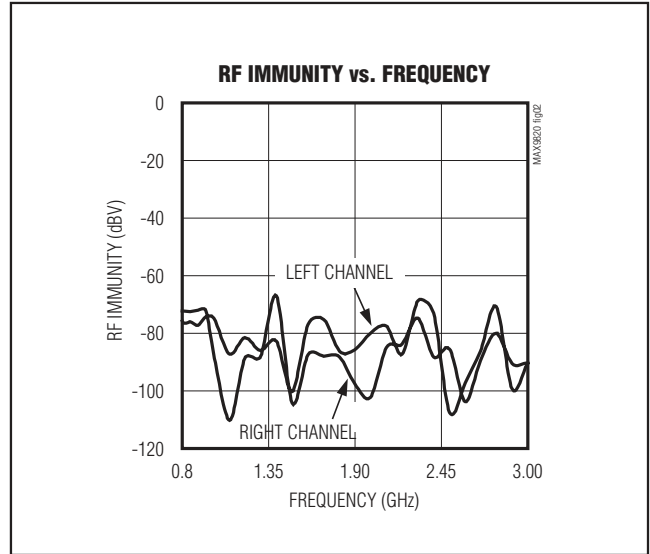
Click-and-Pop Suppression

In conventional single-supply audio amplifiers, the output-coupling capacitor contributes significantly to audible clicks and pops. Upon startup, the amplifier charges the coupling capacitor to its bias voltage, typically half the supply. Likewise, on shutdown, the capacitor is discharged. This results in a DC shift across the capacitor, which appears as an audible transient at the speaker. Since DirectDrive biases the outputs at ground, this problem does not arise. Additionally, the MAX9820 features extensive click-and-pop suppression that eliminates any audible transient sources internal to the device.

RF Susceptibility

Modern audio systems are often subject to RF radiation from sources such as wireless and cellular phone networks. Although the RF radiation is out of the audio band, many signals, GSM signals in particular, contain bursts or modulation at audible frequencies. Most analog amplifiers demodulate the low-frequency envelope, adding noise to the audio signal. The MAX9820 architecture addresses the RF susceptibility problem by rejecting RF noise and preventing it from coupling into the audio band.

DirectDrive Headphone Amplifier with External Gain

Shutdown

The MAX9820 features a low-power shutdown mode that reduces quiescent current consumption to less than 1µA, extending battery life for portable applications. Drive $\overline{SHDN}$ low to disable the amplifiers and the charge pump. In shutdown mode, the amplifier output impedance is set to 600Ω ll R_{FB}. The amplifiers and charge pump are enabled once $\overline{SHDN}$ is driven high.

Applications Information

Power Dissipation

Under normal operating conditions, linear power amplifiers can dissipate a significant amount of power. The maximum power dissipation for each package is given in the *Absolute Maximum Ratings* section or can be calculated by the following equation:

$$P_{DISSPKG(MAX)} = \frac{T_{J(MAX)} - T_A}{\theta_{JA}}$$

where $T_{J(MAX)}$ is +150°C, T_A is the ambient temperature, and θ_{JA} is the reciprocal of the derating factor in °C/W as specified in the *Absolute Maximum Ratings* section.

The MAX9820 has two power dissipation sources: a charge pump and the two output amplifiers. If power dissipation for a given application exceeds the maximum allowed package power dissipation, reduce V_{DD}, increase load impedance, decrease the ambient temperature, or add heatsinking to the device. Large output, supply, and ground traces decrease θ_{JA}, allowing more heat to be transferred from the package to the surrounding air.

Thermal-overload protection limits total power dissipation in the MAX9820. When the junction temperature exceeds 145°C (typ), the thermal protection circuitry disables the amplifier output stage. The amplifiers are enabled once the junction temperature cools by approximately 15°C.

Undervoltage Lockout (UVLO)

The MAX9820 features a UVLO function that prevents the device from operating if the supply voltage falls below 2.2V (min). This feature ensures proper operation during brownout conditions and prevents deep battery discharge. Once the supply voltage reaches the minimum supply voltage range, the MAX9820 charge pump is turned on and the amplifiers are powered, provided that $\overline{SHDN}$ is high.

Component Selection

Input-Coupling Capacitor

The input capacitor (C_{IN}), in conjunction with the input resistor (R_{IN}), forms a highpass filter that removes the DC bias from an incoming signal (see the *Functional Diagram/Typical Operating Circuit*). The AC-coupling capacitor allows the device to bias the signal to an optimum DC level. Assuming zero-source impedance, the -3dB point of the highpass filter is given by:

$$f_{-3dB} = \frac{1}{2\pi R_{IN} C_{IN}}$$

Choose the C_{IN} such that f_{-3dB} is well below the lowest frequency of interest. Setting f_{-3dB} too high affects the device's low-frequency response. Use capacitors whose dielectrics have low-voltage coefficients, such as tantalum or aluminum electrolytic. Capacitors with high-voltage coefficients, such as ceramics, can result in increased distortion at low frequencies.

Charge-Pump Capacitor Selection

Use ceramic capacitors with a low ESR for optimum performance. For optimal performance over the extended temperature range, select capacitors with an X7R or X5R dielectric. Table 2 lists suggested manufacturers.

Table 2. Suggested Capacitor Vendors

SUPPLIER	PHONE	FAX	WEBSITE
Taiyo Yuden	800-348-2496	847-925-0899	www.t-yuden.com
TDK	847-803-6100	847-390-4405	www.component.tdk.com
Murata	770-436-1300	770-436-3030	www.murata.com

MAXIM

MAX9820

Amplifier Gain

The gain of the MAX9820 is set externally using input and feedback resistors (see the *Functional Diagram/ Typical Operating Circuit*). The gain is:

$$A_V = -\frac{R_{FB}}{R_{IN}}(V/V)$$

Choose feedback resistor values in the tens of kΩ range.

Layout and Grounding

Proper layout and grounding are essential for optimum performance. Connect EP and GND together at a single point on the PCB. Ensure ground return resistance is minimized for optimum crosstalk performance. Place the power-supply bypass capacitor, the charge-pump hold capacitor, and the charge-pump flying capacitor as close as possible to the MAX9820. Route all traces that carry switching transients away from the audio signal path.

Functional Diagram/Typical Operating Circuit
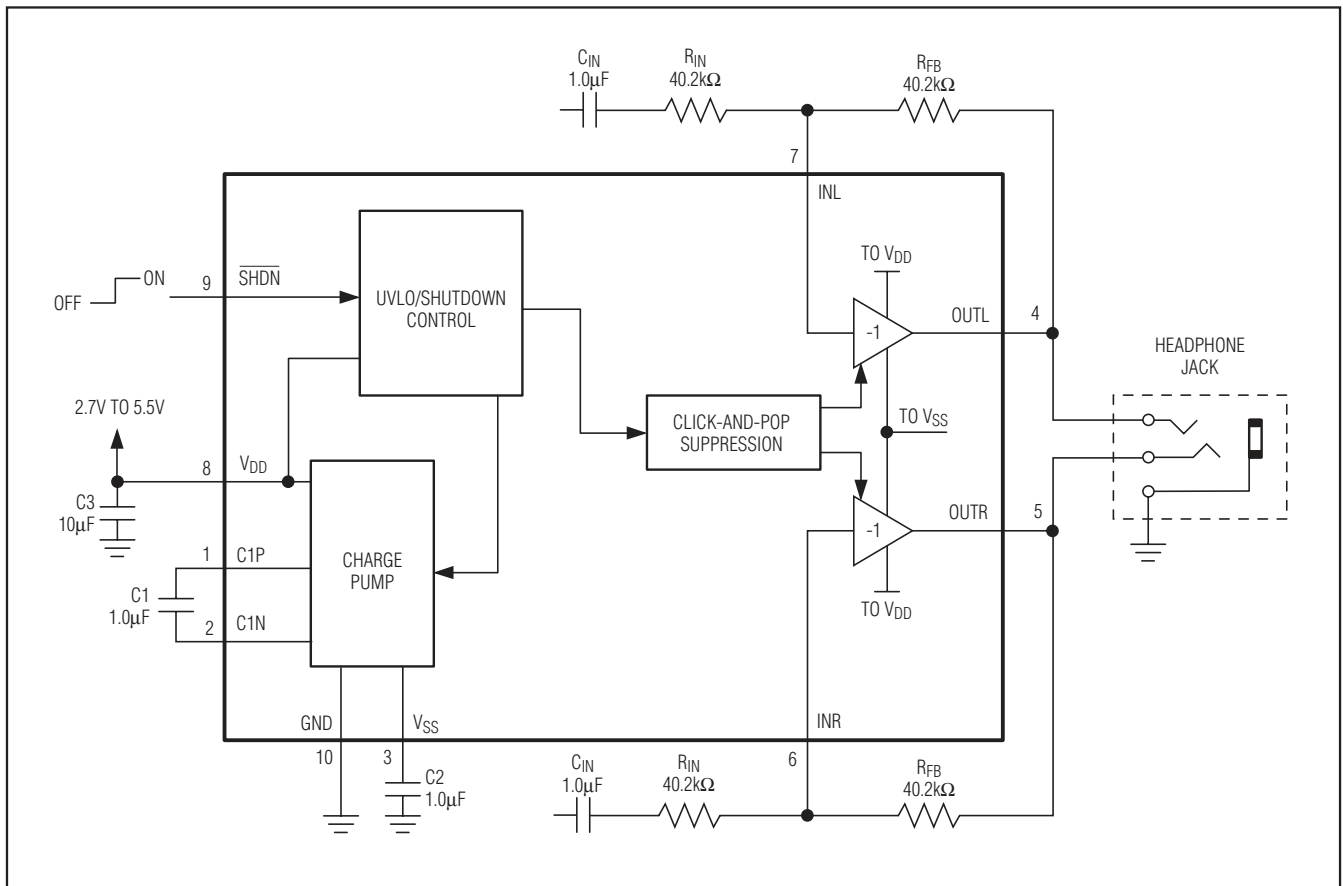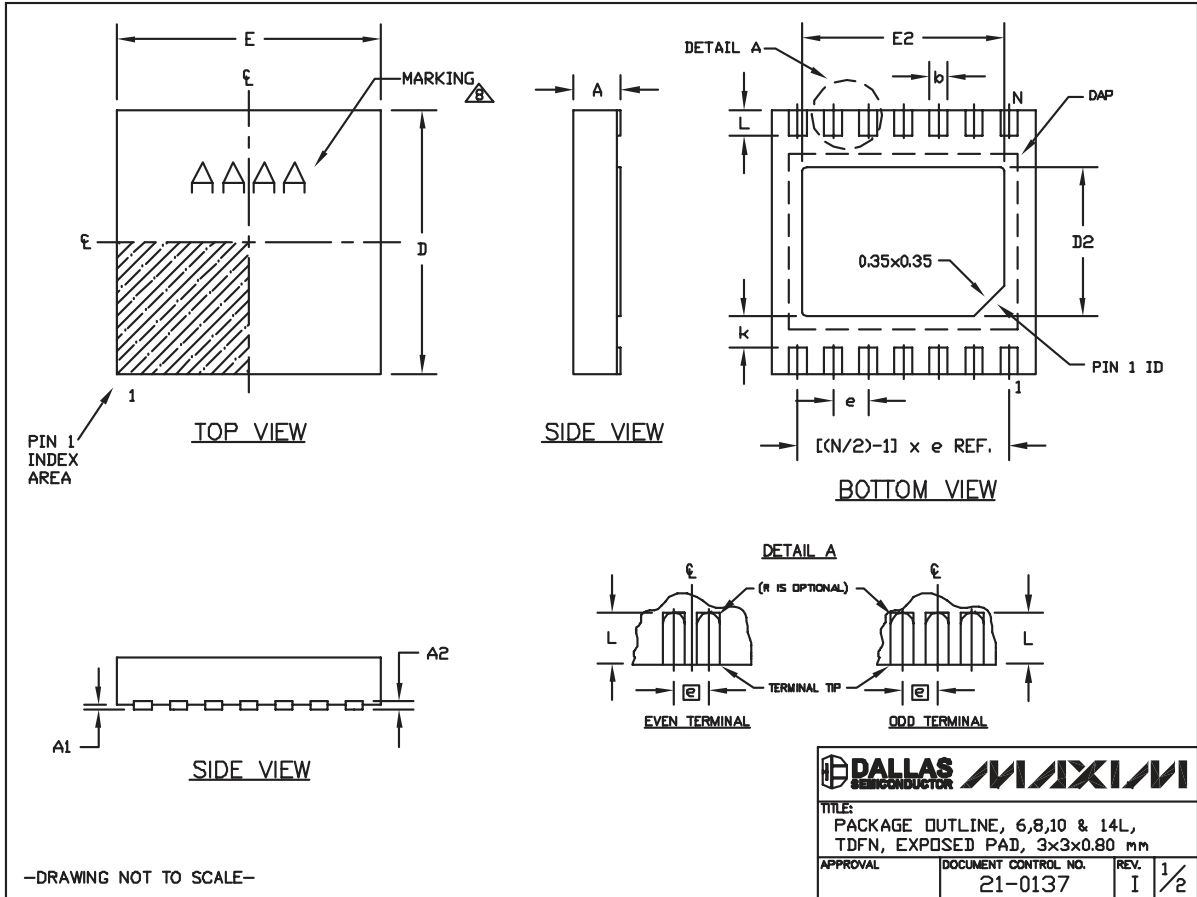

Chip Information

PROCESS: BiCMOS

DirectDrive Headphone Amplifier with External Gain

Package Information

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
10 TDFN-EP	T1033+1	**21-0137**

6, 8, &10L, DFN THIN.EPS

TITLE:
PACKAGE OUTLINE, 6,8,10 & 14L, TDFN, EXPOSED PAD, 3x3x0.80 mm

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0137	I	1/2

Package Information (continued)

COMMON DIMENSIONS		
SYMBOL	MIN.	MAX.
A	0.70	0.80
D	2.90	3.10
E	2.90	3.10
A1	0.00	0.05
L	0.20	0.40
k	0.25 MIN.	
A2	0.20 REF.	

PACKAGE VARIATIONS							
PKG. CODE	N	D2	E2	e	JEDEC SPEC	b	[(N/2)-1] x e
T633-2	6	1.50±0.10	2.30±0.10	0.95 BSC	MO229 / WEEA	0.40±0.05	1.90 REF
T833-2	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
T833-3	8	1.50±0.10	2.30±0.10	0.65 BSC	MO229 / WEEC	0.30±0.05	1.95 REF
T1033-1	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
T1033-2	10	1.50±0.10	2.30±0.10	0.50 BSC	MO229 / WEED-3	0.25±0.05	2.00 REF
T1433-1	14	1.70±0.10	2.30±0.10	0.40 BSC	- - - -	0.20±0.05	2.40 REF
T1433-2	14	1.70±0.10	2.30±0.10	0.40 BSC	- - - -	0.20±0.05	2.40 REF

NOTES:
1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
2. COPLANARITY SHALL NOT EXCEED 0.08 mm.
3. WARPAGE SHALL NOT EXCEED 0.10 mm.
4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).
5. DRAWING CONFORMS TO JEDEC MO229, EXCEPT DIMENSIONS "D2" AND "E2", AND T1433-1 & T1433-2.
6. "N" IS THE TOTAL NUMBER OF LEADS.
7. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
8. MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.

DALLAS SEMICONDUCTOR **MAXIM**

TITLE:
PACKAGE OUTLINE, 6,8,10 & 14L,
TDFN, EXPOSED PAD, 3x3x0.80 mm

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0137	I	2/2

—DRAWING NOT TO SCALE—